

REV. P1.0.0 **NOVEMBER 2009** 

## **GENERAL DESCRIPTION**

The XR5486E-XR5488E family of RS-485 devices are designed for reliable, bidirectional communication on multipoint bus transmission lines. Each device contains one differential driver and one differential receiver. XR5488E is a half-duplex device while the other part numbers are full-duplex. All devices comply with TIA/EIA-485 and TIA/EIA-422 standards. Leadfree and RoHS compliant packages are available for all models.

These devices are ruggedized for use in harsh operating conditions over the entire common mode voltage range from -7V to +12V. Receivers are specially designed to fail-safe to a logic high output state if the inputs are left un-driven or shorted. All RS-485 bus-pins are protected against severe ESD events up to +/-15kV (Air-Gap and Human Body Model) and up to +/-8kV Contact Discharge (IEC-61000-4-2). Drivers are protected from excess current flow caused by bus contention or output short-circuits by both an internal current limit and a thermal-overload shutdown. Devices are rated for Industrial (-40°C to +85°C) operating temperatures. Receivers have exceptionally high input impedance, which places only 1/8th the standard load on a bus. Up to 256 transceivers may coexist while preserving full signal margin.

All devices operate from a single 5.0V power supply and draw negligible quiescent power. All versions except the XR5487E may independently enable and disable their driver and receiver and enter a low power shutdown mode if both driver and receiver are disabled. All outputs maintain high impedance in shutdown or when powered-off.

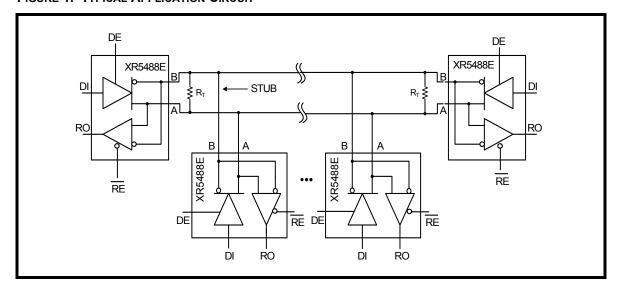
#### **FEATURES**

- 5.0V Single Supply Operation
- High Speed up to 52Mbps
- Advanced Fail-safe Receiver Inputs
- Hot Swap glitch protection on control inputs
- Robust ESD Protection for RS-485 pins
  - +/-15kV Air-Gap Discharge
  - +/-15kV Human Body Model
  - +/-8kV Contact Discharge
- 1/8th Unit Load, 256 transceivers on bus
- Driver short circuit current limit and thermal shutdown for overload protection
- Low Current 1μA shutdown mode (except XR5487)
- Industry standard package footprints

## TYPICAL APPLICATIONS

- Motor Control
- Building Automation
- Security Systems
- Remote Utility Meter Reading

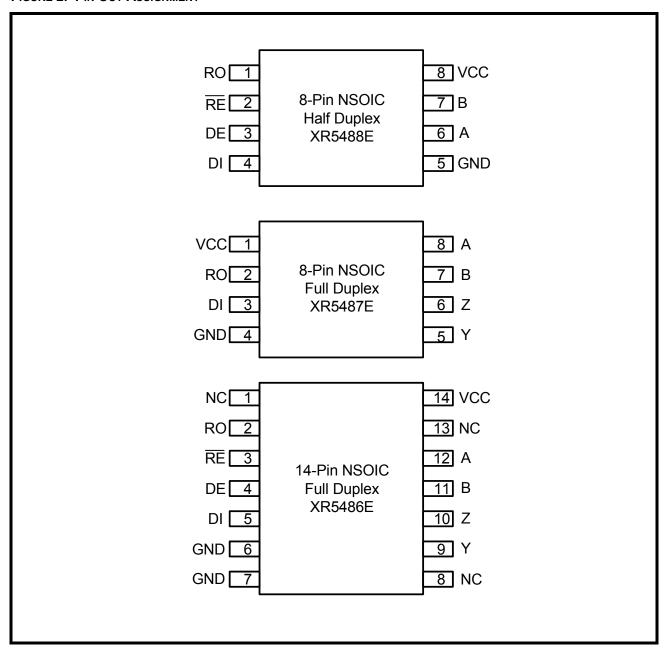
FIGURE 1. TYPICAL APPLICATION CIRCUIT





REV. P1.0.0

FIGURE 2. PIN OUT ASSIGNMENT



## **ORDERING INFORMATION**

PART NUMBER	PACKAGE	OPERATING TEMPERATURE RANGE	DEVICE STATUS
XR5486EID-F	14-pin Narrow SOIC	-40°C to +85°C	Active
XR5487EID-F	8-pin Narrow SOIC	-40°C to +85°C	Active
XR5488EID-F	8-pin Narrow SOIC	-40°C to +85°C	Active

Note: To order Tape and Reel option include "/TR" in ordering part number. All packages are Pb-free/ RoHS compliant.

ULTRA HIGH SPEED RS-485/RS-422 PROFIBUS TRANSCEIVERS WITH 1/8TH UNIT LOAD AND +/-15KV ESD-PROTECTION

# **PIN DESCRIPTIONS**

# **Pin Assignments**

	PIN NUMBER					
HALF DUPLEX	FULL	DUPLEX	PIN NAME	Түре	DESCRIPTION	
XR5488E	XR5487E	XR5486E				
1	2	2	RO	0	Receiver Output. When $\overline{RE}$ is low and if (A-B) $\geq$ -50mV, RO is High. If (A-B) $\leq$ -200mV, RO is Low.	
2	-	3	RE	ı	Receiver Output Enable, When $\overline{RE}$ is Low, RO is enabled. When $\overline{RE}$ is High, RO is high impedance. $\overline{RE}$ should be High and $\overline{DE}$ should be low to enter shutdown mode. $\overline{RE}$ is a hot-swap input.	
3	-	4	DE	ı	Driver Output Enable. When DE is High, outputs are enabled. When DE is low, outputs are high impedance. DE should be low and RE should be High to enter shutdown mode. DE is a hot-swap input.	
4	3	5	DI	ı	Driver Input. With DE high, a low level on DI forces Non-Inverting output low and inverting output high. Similarly, a high level on DI forces Non-Inverting output High and Inverting output Low.	
5	4	6, 7	GND	Pwr	Ground.	
6	-	-	А	0	Non-Inverting Receiver Input and Non-Inverting Driver Output.	
7	-	-	В	0	Inverting Receiver Input and Inverting Driver Output.	
8	1	14	Vcc	Pwr	+5.0V power supply input. Bypass with 0.1uF capacitor.	
-	8	12	Α	I	Non-Inverting Receiver Input.	
-	7	11	В	I	Inverting Receiver Input.	
-	5	9	Y	0	Non-Inverting Driver Output.	
-	6	10	Z	0	Inverting Driver Output.	
-	-	1, 8, 13	NC	-	No Connect, not internally connected.	

Pin type: I=Input, O=Output.

RFV P1 0 0

## **ABSOLUTE MAXIMUM RATINGS**

These are stress ratings only and functional operation of the device at these ratings or any other above those indicated in the operation sections to the specifications below is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect reliability and cause permanent damage to the device.

V <sub>CC</sub>	+7.0V
Input Voltage at control pins (RE, DE)	-0.3V to (V <sub>CC</sub> + 0.3V)
Driver input voltage (DI)	-0.3V to (V <sub>CC</sub> + 0.3V)
Receiver output voltage (RO)	-0.3V to (V <sub>CC</sub> + 0.3V)
Driver output voltage (A, B, Y and Z)	-8V to +13V
Receiver Input Voltage (A, B)	-8V to +13V
Storage Temperature Range	-65°C to + 150°C
Lead Temperature	+300°C
Power Dissipation	

Power Dissipation

Maximum Junction Temperature 150°C

8-Pin SO  $\theta_{JA}$  = 128.4°C/W

14-Pin SO  $\theta_{JA} = 86^{\circ}\text{C/W}$ 

## **CAUTION:**

ESD (Electrostatic Discharge) sensitive device. Permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. Personnel should be properly grounded prior to handling this device. The protective foam should be discharged to the destination socket before devices are removed.

## **ELECTRICAL CHARACTERISTICS**

UNLESS OTHERWISE NOTED: VCC = +5.0V +/-0.25V with T<sub>A</sub> FROM -40°C TO +85°C. TYPICAL VALUES ARE AT VCC = +5.0V AND 25°C.

SYMBOL	PARAMETERS	Min	Түр	Max	Units	Conditions		
DRIVER DC	DRIVER DC CHARACTERISTICS							
				Vcc		No Load		
		2.8				$R_L = 100\Omega$ (RS-422), Figure 3		
$V_{OD}$	Differential Driver Output	2.4			V	$R_L = 54\Omega$ (RS-485), Figure 3		
		2.4				V <sub>CM</sub> = -7V, Figure 4		
		2.4				V <sub>CM</sub> = +12V, Figure 4		
	ΔV <sub>OD</sub> Change in Magnitude of Differential Output	-0.20		0.20		$R_L$ = 100 $\Omega$ (RS-422), Figure 3, See note 1		
۸۷/		-0.20		0.20	V	$R_L$ = 54 $\Omega$ (RS-485), Figure 3, See note 1		
ΔV <sub>OD</sub>		-0.20		0.20	V	V <sub>CM</sub> = -7V, Figure 4, See note 1		
		-0.20		0.20		V <sub>CM</sub> = +12V, Figure 4, See note 1		

ULTRA HIGH SPEED RS-485/RS-422 PROFIBUS TRANSCEIVERS WITH 1/8TH UNIT LOAD AND +/-15KV ESD-PROTECTION

Unless otherwise noted: VCC = +5.0V +/-0.25V with T<sub>A</sub> from -40°C to +85°C. Typical values are at VCC = +5.0V and 25°C.

SYMBOL	PARAMETERS	Min	Түр	Max	Units	Conditions
V <sub>oc</sub>	Driver Common Mode Output Voltage steady state			3.0	V	Figure 3
ΔV <sub>OC</sub>	Change in Magnitude of Common Mode Output Voltage	-0.2		0.2	V	Figure 3, See note 1
I <sub>OSD</sub>	Driver Short Circuit Current Limit	-250		250	mA	$-7V \le V_{OUT} \le +12V$ , Figure 5
I <sub>OL</sub>	Output Leakage Current (Full- Duplex versions, Y and Z pins)	-75		125	μА	DE = 0V, $\overline{RE}$ = 0V, Vcc = 0V or 5V, -7V $\leq$ V <sub>OUT</sub> $\leq$ +12V
V <sub>IH</sub>	Logic Input Thresholds (DI, DE, RE)	2.0			V	Logic Input High
V <sub>IL</sub>	- Logic input Tillesholds (DI, DE, NE)			0.8	V	Logic Input Low
V <sub>HYS</sub>	Driver Input Hysteresis		100		mV	T <sub>A</sub> = 25°C
I <sub>IN</sub>	Logic Input Current (DI, DE and RE)	-1		1	μА	$0V \le IN \le +VCC$ , after first transition
Driver AC Cl	naracteristics					
freq	Data Signaling Rate	52			Mbps	$1/t_{UI}$ , Duty Cycle 40 to 60%, Figure 4, $C_L$ = 50pF, $R_L$ = 54 $\Omega$ .
t <sub>PLH</sub>	Driver Propagation Delay (low to High)	4	tbd	25	ns	$C_L$ = 50pF, $R_L$ = 54 $\Omega$ , Figures 6 and 7
t <sub>PHL</sub>	Driver Propagation Delay (High to Low)	4	tbd	25	ns	$C_L$ = 50pF, $R_L$ = 54 $\Omega$ , Figures 6 and 7
t <sub>R</sub>	Driver Rise Time	2		8	ns	$C_L$ = 50pF, $R_L$ = 54 $\Omega$ , Figures 6 and 7
t <sub>F</sub>	Driver Fall time	2		8	ns	$C_L$ = 50pF, $R_L$ = 54 $\Omega$ , Figures 6 and 7
t <sub>PLH-</sub> t <sub>PHL</sub>	Differential Pulse Skew			+/-3	ns	Figures 6 and 7
t <sub>ZH</sub>	Driver Enable to Output High			60	ns	$C_L$ = 50pF, $R_L$ = 500 $\Omega$ , Figures 8 and 9
t <sub>ZL</sub>	Driver Enable to Output Low			60	ns	$C_L$ = 50pF, $R_L$ = 500 $\Omega$ , Figures 10 and 11
t <sub>HZ</sub>	Driver Disable from Output High			60	ns	$C_L$ = 50pF, $R_L$ = 500 $\Omega$ , Figures 8 and 9
t <sub>LZ</sub>	Driver Disable from Output Low			60	ns	$C_L$ = 50pF, $R_L$ = 500 $\Omega$ , Figures 10 and 11
t <sub>ZV</sub>	Shutdown to Driver Output Valid			1	μS	$C_L = 50pF, R_L = 500\Omega$
t <sub>SHDN</sub>	Time to Shutdown	50	200	600	ns	Notes 2, 3 and 4
RECEIVER D	C CHARACTERISTICS					
I <sub>IN</sub>	Input Current (A, B pins)	-75		125	μА	DE = 0, Vcc = 0 or 3.3V $V_A$ or $V_B$ = 12V, other input 0V $V_A$ or $V_B$ = -7V, other input 0V



RFV P100

UNLESS OTHERWISE NOTED: VCC = +5.0V +/-0.25V WITH T<sub>A</sub> FROM -40°C TO +85°C. TYPICAL VALUES ARE AT VCC = +5.0V AND 25°C.

SYMBOL	PARAMETERS	Min	Түр	Max	Units	Conditions	
$V_{IH}$	Receiver Differential Thresholds			-50	mV	$-7V \le V_{CM} \le +12V$ , rising	
V <sub>IL</sub>	(V <sub>A</sub> - V <sub>B</sub> )	-200			mV	$-7V \le V_{CM} \le +12V$ , falling	
	Receiver Input Hysteresis		25		mV	V <sub>CM</sub> = 0V	
V <sub>OH</sub>	Receiver Output Voltage High	Vcc - 1.2			V	I <sub>OUT</sub> = -8mA, V <sub>ID</sub> = -50mV	
V <sub>OL</sub>	Receiver Output Voltage Low			0.4	V	I <sub>OUT</sub> = 8mA, V <sub>ID</sub> = -200mV	
I <sub>OZ</sub>	High-Z Receiver Output Current			+/-1	μА	$\overline{\text{RE}} = \text{Vcc}, 0.40 \le \text{V}_{\text{OUT}} \le +2.4\text{V}$	
l <sub>oss</sub>	Receiver Output Short Circuit Current			+/-125	mA	0 ≤ V <sub>RO</sub> ≤ Vcc	
R <sub>IN</sub>	Receiver Input Resistance	96			ΚΩ	$-7V \le V_{CM} \le +12V$	
RECEIVER A	C CHARACTERISTICS	!	!	!	!		
freq	Data Signaling Rate	52			Mbps	1/t <sub>UI</sub> , Duty Cycle 40 to 60%, C <sub>L</sub> = 15pF	
t <sub>PLH</sub>	Receiver Propagation Delay (Low to High)		20	30	ns	$V_{ID}$ = +/-2V, $C_{L}$ = 15pF, Figures 12 and 13	
t <sub>PHL</sub>	Receiver Propagation Delay (High to Low)		20	30	ns	$V_{ID}$ = +/-2V, $C_{L}$ = 15pF, Figures 12 and 13	
skew	Receiver Propagation Delay Skew			+/-3	ns	$V_{ID}$ = +/-2V, $C_L$ = 15pF, Figures 12 and 13 skew = $ t_{PLH}t_{PHL} $	
t <sub>R</sub>	Receiver Output Rise Time		2	4	ns	C <sub>L</sub> = 15pF	
t <sub>F</sub>	Receiver Output Fall Time		2	4	ns	C <sub>L</sub> = 15pF	
t <sub>ZH</sub>	Receiver Enable to Output High			40	ns	$C_L$ = 15pF, $R_L$ = 1k $\Omega$ , Figures 14 and 15	
t <sub>ZL</sub>	Receiver Enable to Output Low			40	ns	$C_L$ = 15pF, $R_L$ = 1k $\Omega$ , Figures 14 and 16	
t <sub>HZ</sub>	Receiver Disable from Output High			40	ns	$C_L$ = 15pF, $R_L$ = 1k $\Omega$ , Figures 14 and 17	
t <sub>LZ</sub>	Receiver Disable from Output Low			40	ns	$C_L$ = 15pF, $R_L$ = 1k $\Omega$ , Figures 14 and 18	
t <sub>ZH(SHDN)</sub>	Shutdown to Receiver Output Valid High			1	μS	$C_L$ = 15pF, $R_L$ = 1k $\Omega$ , Figures 14 and 15	
t <sub>ZL(SHDN)</sub>	Shutdown to Receiver Output Valid Low			1	μS	$C_L$ = 15pF, $R_L$ = 1k $\Omega$ , Figures 14 and 16	
t <sub>SHDN</sub>	Time to Shutdown	50	200	600	ns	Notes 2, 3 and 4	
	POWER REQUIREMENTS AND RECOMMENDED OPERATING CONDITIONS						
Vcc	Supply Voltage	4.75	5.0	5.25	V		

ULTRA HIGH SPEED RS-485/RS-422 PROFIBUS TRANSCEIVERS WITH 1/8TH UNIT LOAD AND +/-15KV ESD-PROTECTION

UNLESS OTHERWISE NOTED: VCC = +5.0V + /-0.25V WITH T<sub>A</sub> FROM  $-40^{\circ}$ C TO  $+85^{\circ}$ C. TYPICAL VALUES ARE AT VCC = +5.0V AND  $25^{\circ}$ C.

SYMBOL	PARAMETERS	Min	Түр	MAX	Units	Conditions
I <sub>CC1</sub>	Supply Current - Active Mode		800	1500	μА	No Load, DE = RE = Vcc or 0V, DI = 0V or Vcc
I <sub>CC2</sub>	Supply Current - Shutdown Mode			1	μА	DE = 0V, RE = Vcc, DI = Vcc or 0V
T <sub>SD</sub>	Thermal Shutdown Temperature		165		°C	
	Thermal Shutdown Hysteresis		20		°C	
			+/-15		kV	Human Body Model
	ESD Protection at Pins A, B, Y and Z pins		+/-15		kV	EN-61000-4-2 Air Discharge
	·		+/-8		kV	EN-61000-4-2 Contact
	ESD Protection for RO, DI, DE and		+/-2		kV	Human Body Model
	RE pins		+/-200		V	Machine Model

## Note:

- 1. Change in Magnitude of Differential Output Voltage and Change in Magnitude of Common Mode Output Voltage are the changes in output voltage when DI input changes state.
- 2. The transceivers are put into shutdown by bringing RE High and DE Low simultaneously for at least 600ns. If the control inputs are in this state for less than 50ns, the device is guaranteed not enter shutdown. If the enable inputs are held in this state for at least 600ns the device is assured to be in shutdown. Note that the receiver and driver enable times increase during shutdown.
- 3. Guaranteed by design and bench characterization.
- 4. Except devices which do not have DE or  $\overline{RE}$  inputs.



FIGURE 3. DRIVER DC TEST CIRCUIT

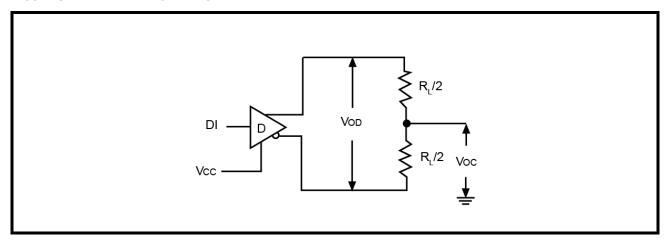


FIGURE 4. DRIVER COMMON MODE LOAD TEST

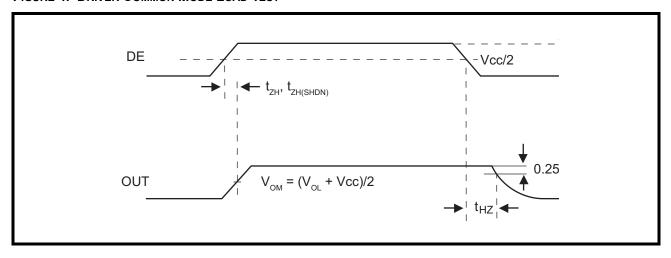


FIGURE 5. DRIVER SHORT CIRCUIT CURRENT LIMIT TEST

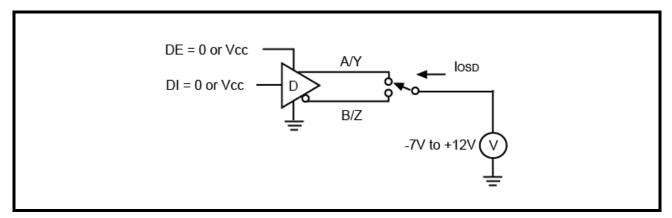


FIGURE 6. DRIVER PROPAGATION DELAY TEST CIRCUIT

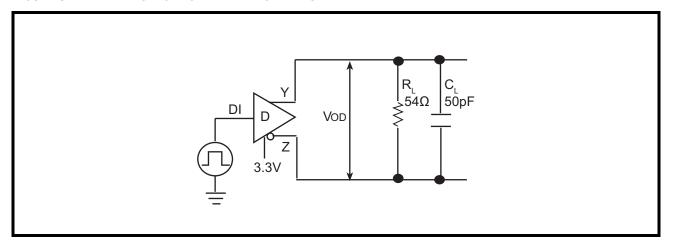


FIGURE 7. DRIVER PROPAGATION DELAY TIMING DIAGRAM

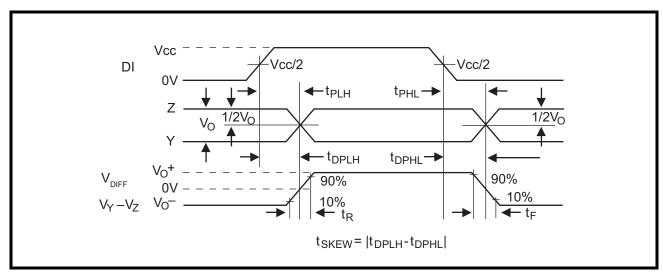
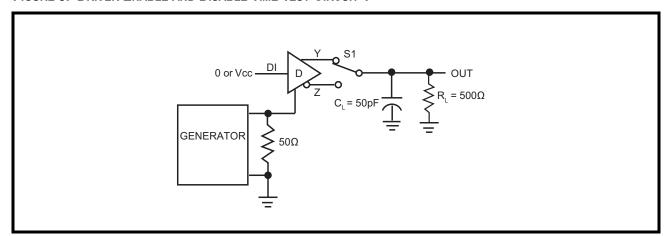


FIGURE 8. DRIVER ENABLE AND DISABLE TIME TEST CIRCUIT 1



REV. P1.0.0

FIGURE 9. DRIVER ENABLE DISABLE TIMING DIAGRAM 1

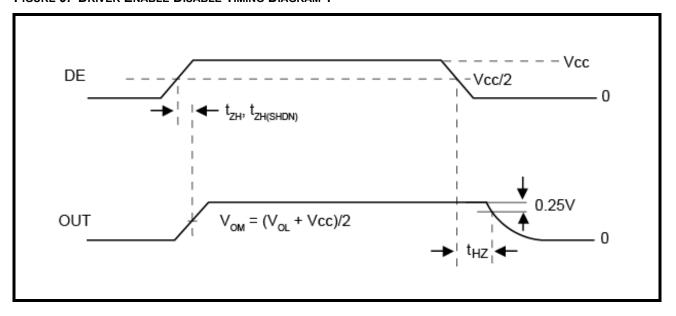
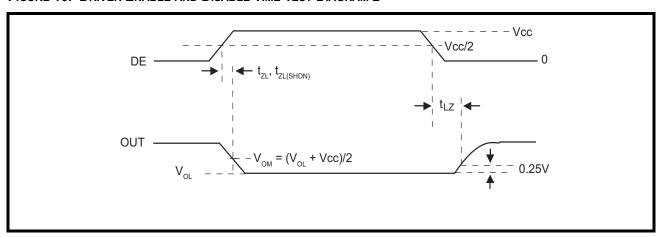


FIGURE 10. DRIVER ENABLE AND DISABLE TIME TEST DIAGRAM 2





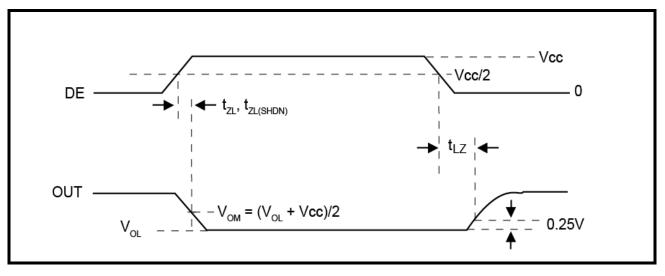


FIGURE 12. RECEIVER PROPAGATION DELAY TEST CIRCUIT

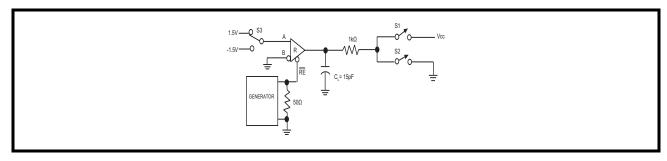


FIGURE 13. RECEIVER PROPAGATION DELAY TIMING DIAGRAM

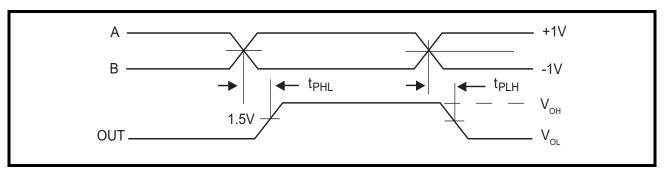




FIGURE 14. RECEIVER ENABLE AND DISABLE TIMES TEST CIRCUIT

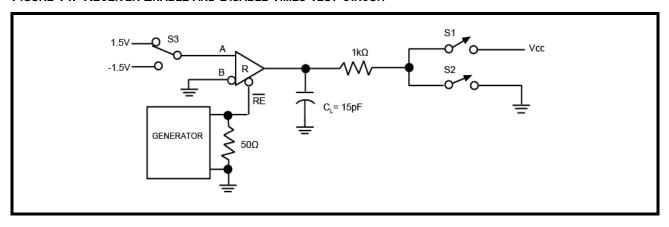


FIGURE 15. RECEIVER ENABLE AND DISABLE TIMING DIAGRAM 1

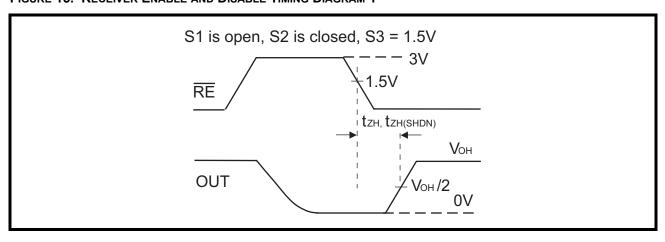


FIGURE 16. RECEIVER ENABLE AND DISABLE TIMING DIAGRAM 2

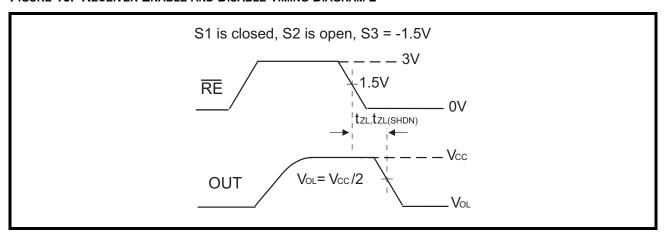




FIGURE 17. RECEIVER ENABLE AND DISABLE TIMING DIAGRAM 3

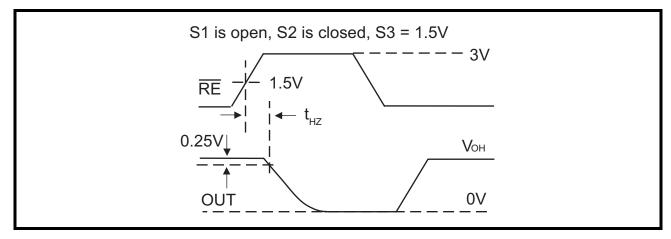
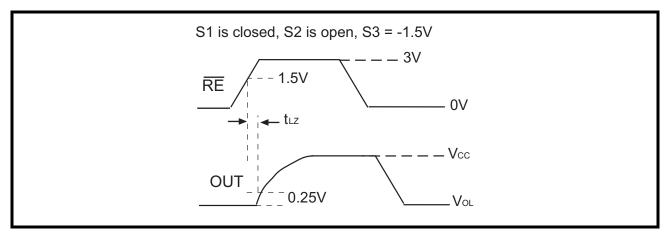


FIGURE 18. RECEIVER ENABLE AND DISABLE TIMING DIAGRAM 4





REV. P1.0.0

#### 1.0 PRODUCT DESCRIPTION

XR5486E-XR5488E is a family of advanced RS-485/RS-422 transceivers. Each contain one driver and one receiver. The SP5488E is a half-duplex design while the SP5486E and SP5487E are full-duplex designs. All devices operate from a single 5.0V power supply. These devices feature failsafe circuitry that guarantees a logic-high receiver output when the inputs are open or shorted, or when they are connected to a terminated transmission line with all drivers disabled. The control pins RE and DE feature a hotswap capability allowing live insertion without spurious data transfer. The drivers are not slew rate limited making transmit speeds up to 52Mbps possible. Drivers are output short-circuit current limited. Thermal-shutdown circuitry protects drivers against excessive power dissipation. When activited, the thermal-shutdown circuitry forces the driver outptus into a high-impedance state.

### **ADVANCED FAILSAFE**

Ordinary RS-485 differential receivers will be in an indeterminate state whenever the data bus is not being actively driven. The Advanced Failsafe feature of the XR5486E family guarantees a logic-high receiver output when the receiver inputs are open or shorted, or when they are connected to a terminated transmission line with all drivers disabled. In a terminated bus with all transmitters disabled, the receivers' differential input voltage is pulled to 0V by the termination. The SP5486E family interprets 0V differential as a logic high with a minimum 50mV noise margin while maintaining compliance with the EIA/TIA-485 standard of +/-200mV.

#### **HOT-SWAP CAPABILITY**

When a micro-processor or other logic device undergoes its power-up sequence, its logic-outputs are typically at high impedance. In this state they are unable to drive the DE and RE signals to a defined logic level. During this period, noise, parasitic coupling or leakage from other devices could cause standard CMOS enable inputs to drift to an incorrect logic level.

If circuit boards are inserted into an energized backplane (commonly called "live insertion" or "hot-swap") power may suddenly be applied to all circuits. Without the hot-swap capability, this situation could improperly enable the transceiver's driver or receiver, driving invalid data onto shared busses and possibly causing driver contention or device damage.

The XR5486E-XR5488E family contains a special power-on-reset circuit that holds the driver enable and receiver enable inactive for approximately 10 microseconds. After this initial power-up sequence the hot-swap circuit becomes transparent and driver enable and receiver enable resume their normal un-skewed functions and timings.

#### +/-15kV ESD PROTECTION

ESD protection structures are incorporated on all pins to protect against electrostatic discharges encountered during handling and assembly. The driver outputs and receiver inputs of the XR5486E family have extra protection against static electricity. Exar uses state of the art structures to protect these pins against ESD of +/-15kV without damage. The ESD structures withstand high ESD in all states: normal operation, shutdown and powered down. After an ESD event, the XR5486E-XR5488E keep operating without latch-up or damage.

ESD protection can be tested in various ways. The transmitter outputs and receiver inputs of the XR5486E-XR5488E are characterized for protection to the following limits:

- +/-15kV using the Human Body Model
- +/-8kV using the Contact Discharge Model
- +/-15kV Air-gap using the Airgap Discharge Model

#### **ESD TEST CONDITIONS**

ESD performance depends on a variety of conditions. Contact Exar for a reliability report that documents test setup, methodology and results.

ULTRA HIGH SPEED RS-485/RS-422 PROFIBUS TRANSCEIVERS WITH 1/8TH UNIT LOAD AND +/-15KV ESD-PROTECTION

#### IEC 61000-4-2

The IEC 61000-4-2 standard covers ESD testing and performance of finished equipment. However, it does not specifically refer to integrated circuits. The XR5486E family helps you design equipment to meet IEC 61000-4-2, without sacrificing board-space and cost for external ESD-protection components.

The major differences between tests done using the Human body model and IEC 61000-4-2 is a higher peak current in IEC 61000-4-2. Series resistance is lower in the IEC 61000-4-2 model. Hence, the ESD withstand voltage measured to IEC 61000-4-2 is generally lower than that of human body model.

The air-gap test involves approaching the device with a charged probe. The contact discharge method connects the probe to the device before the probe is energized.

#### **MACHINE MODEL**

The machine model for ESD tests all pins using a 200pF storage capacitor and zero discharge resistance. The objective is to emulate the stress caused when I/O pins are contacted by handling equipment during test and assembly.

#### 256 TRANSCEIVERS ON THE BUS

The standard RS-485 receiver input impedance is 12k Ohms (1 unit load). A standard drive can driver up to 32 unit loads. The XR5486E family of transceivers have only a 1/8<sup>th</sup> unit load receiver input impedance of 96k Ohms, thereby allowing eight times as many, up to 256, transceivers to be connected in parallel on a communication line. Any combination of these devices and other RS-485 transceivers up to a total of 32 unit loads may be connected to the line.

## LOW POWER SHUTDOWN MODE

Low-power shutdown mode is initiated by bringing both  $\overline{RE}$  high and DE low simultaneously. While in shutdown devices draw only 50nA of supply current. DE and  $\overline{RE}$  may be tied together and driven by a single control signal. Devices are guaranteed not to enter shutdown if  $\overline{RE}$  is high and DE is low for less than 50ns. If the inputs are in this state for at least 600ns, the parts are shutdown.

Enable times  $t_{ZH}$  and  $t_{ZL}$  apply when the part is not in low-power shutdown state. Enable times  $t_{ZH(SHDN)}$  and  $t_{ZL(SHDN)}$  apply when the parts are shutdown. The drivers and receivers take longer to become enabled from low-power shutdown  $t_{ZH(SHDN)}$  and  $t_{ZL(SHDN)}$  than from driver / receiver disable mode ( $t_{ZH}$  and  $t_{ZL}$ ).

#### **DRIVER OUTPUT PROTECTION**

Two mechanisms prevent excessive output current and power dissipation caused by faults or by bus contention. First, a driver current limit on the output stage provides immediate protection against short circuits over the whole common-mode voltage range. Second, a thermal-shutdown circuit forces the driver outputs into a high-impedance state if junction temperature becomes excessive.

#### LINE LENGTH

The RS-485/RS-422 standard covers line lengths up to 4000ft. Maximum achievable line length is a function of signal attenuation and noise. Termination prevents signal reflections by eliminating the impedance mismatches on a transmission line. Line termination is generally used if rise and fall times are shorter than the round-trip signal propagation time.

REV. P1.0.0

## 2.0 FUNCTION TABLES

**TABLE 1: FULL DUPLEX 14 PIN** 

TRANSMITTING					
	Inputs	Out	puts		
RE	DE	DI	Y	Z	
Х	1	1	1	0	
Х	1	0	0	1	
0	0	Х	Hig	h-Z	
1	0	Х	Shut	down	

**TABLE 2: FULL DUPLEX 8 PIN** 

TRANSMITTING				
Input	Outputs			
DI	Y	Z		
1	1	0		
0	0	1		

**TABLE 3: HALF DUPLEX** 

TRANSMITTING					
	Inputs		Out	puts	
RE	DE	DI	А	В	
Х	1	1	1	0	
Х	1	0	0	1	
0	0	Х	Hig	h-Z	
1	0	Х	Shute	down	

**TABLE 4: FULL DUPLEX 14 PIN** 

RECEIVING					
Inputs Ouptu					
RE	DE	V <sub>A</sub> - V <sub>B</sub>	RO		
0	Х	≥ -50mV	1		
0	X	≤ -200mV	0		
0	Х	Open/Shorted	1		
1	1	Х	High-Z		
1	0	X	Shutdown		

**TABLE 5: FULL DUPLEX 8 PIN** 

RECEIVING				
Inputs	Output			
V <sub>A</sub> - V <sub>B</sub>	RO			
≥ -50mV	1			
≤ -200mV	0			
Open/Shorted	1			

**TABLE 6: HALF DUPLEX** 

RECEIVING							
	Output						
RE	DE	V <sub>A</sub> - V <sub>B</sub>	RO				
0	Х	≥ -50mV	1				
0	Х	≤ -200mV	0				
0	Х	Open/Shorted	1				
1	1	Х	High-Z				
1	0	Х	Shutdown				

Note: Receiver inputs -200mV <  $V_{\rm A}$  -  $V_{\rm B}$  < -50mV should be considered indeterminate.

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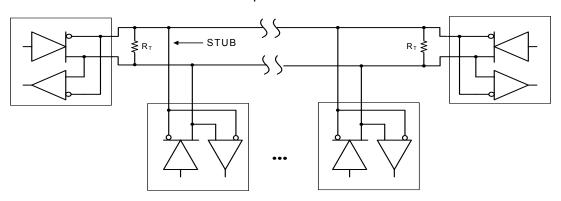
## 3.0 PRODUCT SELECTOR GUIDE

**TABLE 7: SELECTION GUIDE** 

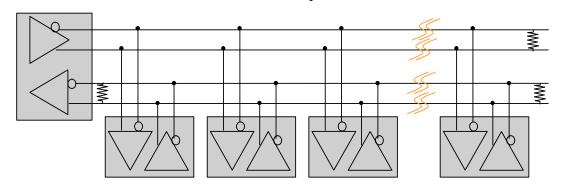
PART NUMBER	DUPLEX	DATA RATE MBPS	SHUTDOWN	RECEIVER AND DRIVER ENABLE	TRANS ON BUS	FOOT-PRINT
XR5486E	Full	52	Yes	Yes	256	SN75180
XR5487E	Full	52	No	No	256	SN75179
XR5488E	Half	52	Yes	Yes	256	SN75176

## 4.0 TYPICAL APPLICATIONS:

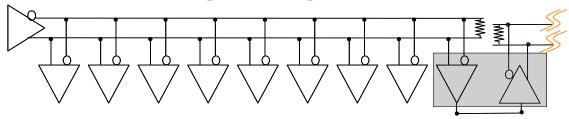
Half-Duplex Network



# Bi-Directional Full-Duplex Network



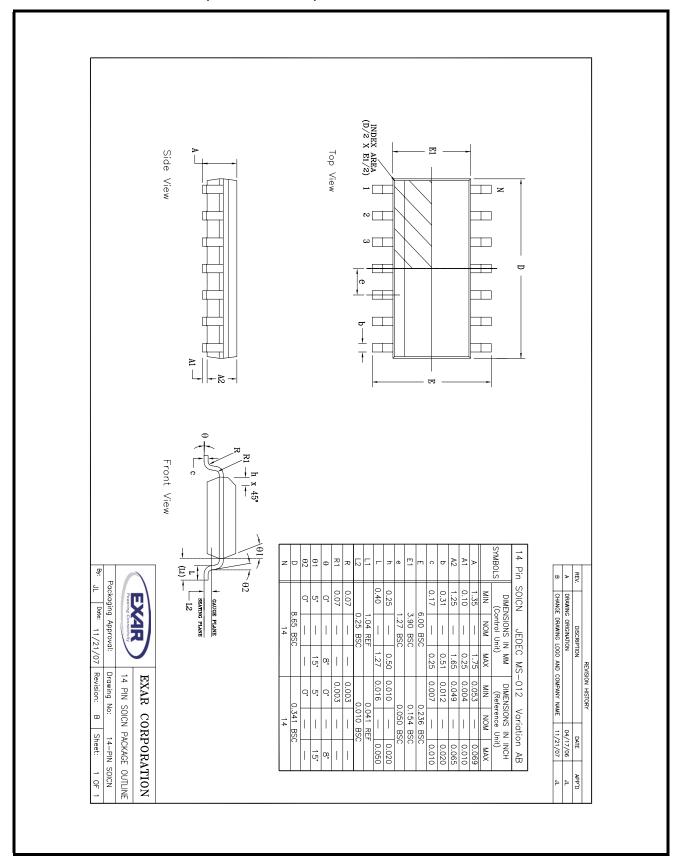
# Point to Multi-point with Repeater



Repeater (optional)

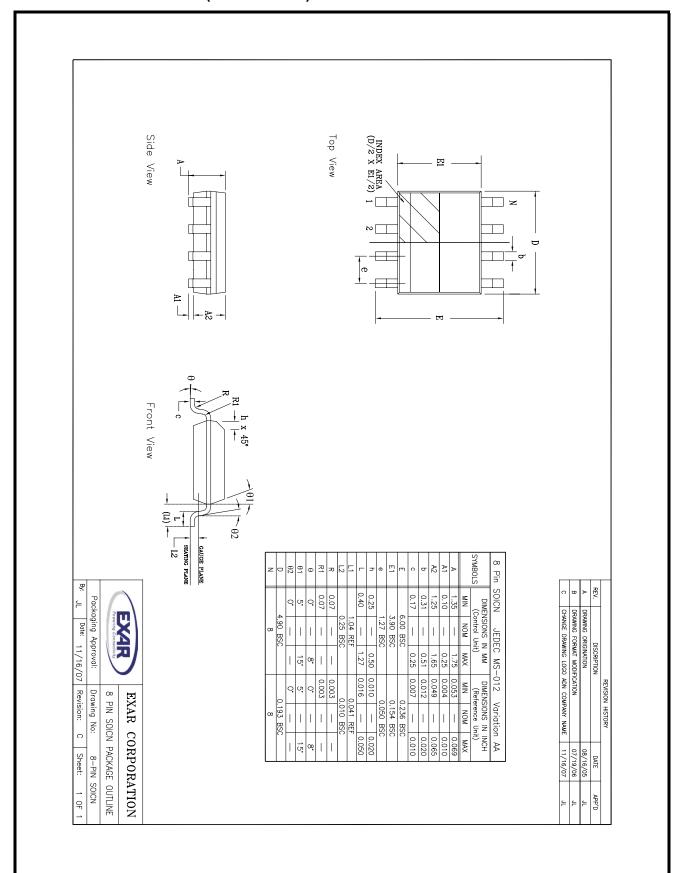
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## **PACKAGE DIMENSIONS (14 PIN NSOIC)**





# **PACKAGE DIMENSIONS (8 PIN NSOIC)**





REV. P1.0.0

#### REVISION HISTORY

DATE	REVISION	DESCRIPTION	
November 2009	Rev P1.0.0	Preliminary datasheet.	

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